

# MOSFET

## OptiMOS™ 6 Power-Transistor, 100 V

### Features

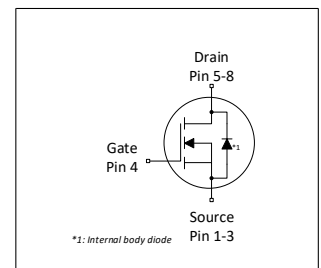
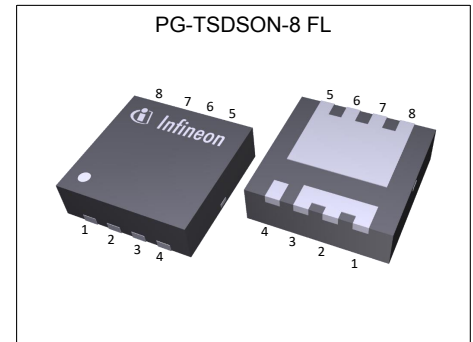
- N-channel, normal level
- Very low on-resistance  $R_{DS(on)}$
- Excellent gate charge x  $R_{DS(on)}$  product (FOM)
- Very low reverse recovery charge ( $Q_{rr}$ )
- High avalanche energy rating
- 175°C operating temperature
- Optimized for high frequency switching and synchronous rectification
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- MSL 1 classified according to J-STD-020

### Product validation

Fully qualified according to JEDEC for Industrial Applications

**Table 1 Key Performance Parameters**

Parameter	Value	Unit
$V_{DS}$	100	V
$R_{DS(on),max}$	23	m $\Omega$
$I_D$	31	A
$Q_{oss}$	14	nC
$Q_G(0V...10V)$	7.4	nC
$Q_{rr}(100A/\mu s)$	23	nC



RoHS

Type / Ordering Code	Package	Marking	Related Links
ISZ230N10NM6	PG-TSDSON-8 FL	230N1N6	-

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## 1 Maximum ratings

at  $T_A=25\text{ °C}$ , unless otherwise specified

**Table 2 Maximum ratings**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Continuous drain current <sup>1)</sup>	$I_D$	-	-	31 22 19 7.7	A	$V_{GS}=10\text{ V}$ , $T_C=25\text{ °C}$ $V_{GS}=10\text{ V}$ , $T_C=100\text{ °C}$ $V_{GS}=8\text{ V}$ , $T_C=100\text{ °C}$ $V_{GS}=10\text{ V}$ , $T_A=25\text{ °C}$ , $R_{thJA}=50\text{ °C/W}^2)$
Pulsed drain current <sup>3)</sup>	$I_{D,pulse}$	-	-	124	A	$T_A=25\text{ °C}$
Avalanche current, single pulse <sup>4)</sup>	$I_{AS}$	-	-	10	A	$T_C=25\text{ °C}$
Avalanche energy, single pulse	$E_{AS}$	-	-	65	mJ	$I_D=4\text{ A}$ , $R_{GS}=25\text{ }\Omega$
Gate source voltage	$V_{GS}$	-20	-	20	V	-
Power dissipation	$P_{tot}$	-	-	48 3.0	W	$T_C=25\text{ °C}$ $T_A=25\text{ °C}$ , $R_{thJA}=50\text{ °C/W}^2)$
Operating and storage temperature	$T_j$ , $T_{stg}$	-55	-	175	°C	-

## 2 Thermal characteristics

**Table 3 Thermal characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Thermal resistance, junction - case, bottom	$R_{thJC}$	-	1.6	3.1	°C/W	-
Thermal resistance, junction - case, top	$R_{thJC}$	-	-	20	°C/W	-
Thermal resistance, junction - ambient, 6 cm <sup>2</sup> cooling area	$R_{thJA}$	-	-	50	°C/W	-

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

<sup>2)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information

### 3 Electrical characteristics

at  $T_j=25\text{ °C}$ , unless otherwise specified

**Table 4 Static characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Drain-source breakdown voltage	$V_{(BR)DSS}$	100	-	-	V	$V_{GS}=0\text{ V}$ , $I_D=1\text{ mA}$
Gate threshold voltage	$V_{GS(th)}$	2.3	2.8	3.3	V	$V_{DS}=V_{GS}$ , $I_D=13\text{ }\mu\text{A}$
Zero gate voltage drain current	$I_{DSS}$	-	0.1 10	1.0 100	$\mu\text{A}$	$V_{DS}=80\text{ V}$ , $V_{GS}=0\text{ V}$ , $T_j=25\text{ °C}$ $V_{DS}=80\text{ V}$ , $V_{GS}=0\text{ V}$ , $T_j=125\text{ °C}^{1)}$
Gate-source leakage current	$I_{GSS}$	-	10	100	nA	$V_{GS}=20\text{ V}$ , $V_{DS}=0\text{ V}$
Drain-source on-state resistance	$R_{DS(on)}$	-	19.6 23.8	23 30	$\text{m}\Omega$	$V_{GS}=10\text{ V}$ , $I_D=10\text{ A}$ $V_{GS}=8\text{ V}$ , $I_D=5\text{ A}$
Gate resistance	$R_G$	0.55	1.0	1.65	$\Omega$	-
Transconductance	$g_{fs}$	6.3	13	-	S	$ V_{DS} \geq 2 I_D /R_{DS(on)max}$ , $I_D=10\text{ A}$

**Table 5 Dynamic characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Input capacitance	$C_{iss}$	-	530	690	pF	$V_{GS}=0\text{ V}$ , $V_{DS}=50\text{ V}$ , $f=1\text{ MHz}$
Output capacitance <sup>1)</sup>	$C_{oss}$	-	120	150	pF	$V_{GS}=0\text{ V}$ , $V_{DS}=50\text{ V}$ , $f=1\text{ MHz}$
Reverse transfer capacitance <sup>1)</sup>	$C_{rss}$	-	6.5	9.8	pF	$V_{GS}=0\text{ V}$ , $V_{DS}=50\text{ V}$ , $f=1\text{ MHz}$
Turn-on delay time	$t_{d(on)}$	-	4	-	ns	$V_{DD}=50\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=5\text{ A}$ , $R_{G,ext}=1.6\text{ }\Omega$
Rise time	$t_r$	-	1	-	ns	$V_{DD}=50\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=5\text{ A}$ , $R_{G,ext}=1.6\text{ }\Omega$
Turn-off delay time	$t_{d(off)}$	-	6.5	-	ns	$V_{DD}=50\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=5\text{ A}$ , $R_{G,ext}=1.6\text{ }\Omega$
Fall time	$t_f$	-	7	-	ns	$V_{DD}=50\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=5\text{ A}$ , $R_{G,ext}=1.6\text{ }\Omega$

**Table 6 Gate charge characteristics<sup>2)</sup>**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Gate to source charge <sup>1)</sup>	$Q_{gs}$	-	2.5	3.3	nC	$V_{DD}=50\text{ V}$ , $I_D=5\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$
Gate charge at threshold <sup>1)</sup>	$Q_{g(th)}$	-	1.5	1.8	nC	$V_{DD}=50\text{ V}$ , $I_D=5\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$
Gate to drain charge <sup>1)</sup>	$Q_{gd}$	-	1.5	2.3	nC	$V_{DD}=50\text{ V}$ , $I_D=5\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$
Switching charge	$Q_{sw}$	-	2.5	-	nC	$V_{DD}=50\text{ V}$ , $I_D=5\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$
Gate charge total <sup>1)</sup>	$Q_g$	-	7.4	9.3	nC	$V_{DD}=50\text{ V}$ , $I_D=5\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$
Gate plateau voltage	$V_{plateau}$	-	4.8	-	V	$V_{DD}=50\text{ V}$ , $I_D=5\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$
Gate charge total, sync. FET	$Q_{g(sync)}$	-	6.5	-	nC	$V_{DS}=0.1\text{ V}$ , $V_{GS}=0\text{ to }10\text{ V}$
Output charge <sup>1)</sup>	$Q_{oss}$	-	14	17	nC	$V_{DS}=50\text{ V}$ , $V_{GS}=0\text{ V}$

<sup>1)</sup> Defined by design. Not subject to production test.

<sup>2)</sup> See "Gate charge waveforms" for parameter definition

**Table 7 Reverse diode**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Diode continuous forward current	$I_S$	-	-	31	A	$T_C=25\text{ °C}$
Diode pulse current	$I_{S,pulse}$	-	-	124	A	$T_C=25\text{ °C}$
Diode forward voltage	$V_{SD}$	-	0.84	1.0	V	$V_{GS}=0\text{ V}, I_F=10\text{ A}, T_j=25\text{ °C}$
Reverse recovery time <sup>1)</sup>	$t_{rr}$	-	30	45	ns	$V_R=50\text{ V}, I_F=5\text{ A}, di_F/dt=100\text{ A}/\mu\text{s}$
Reverse recovery charge <sup>1)</sup>	$Q_{rr}$	-	23	34.5	nC	$V_R=50\text{ V}, I_F=5\text{ A}, di_F/dt=100\text{ A}/\mu\text{s}$
Reverse recovery time <sup>1)</sup>	$t_{rr}$	-	14	21	ns	$V_R=50\text{ V}, I_F=5\text{ A}, di_F/dt=1000\text{ A}/\mu\text{s}$
Reverse recovery charge <sup>1)</sup>	$Q_{rr}$	-	86.5	130	nC	$V_R=50\text{ V}, I_F=5\text{ A}, di_F/dt=1000\text{ A}/\mu\text{s}$

<sup>1)</sup> Defined by design. Not subject to production test.

### 4 Electrical characteristics diagrams

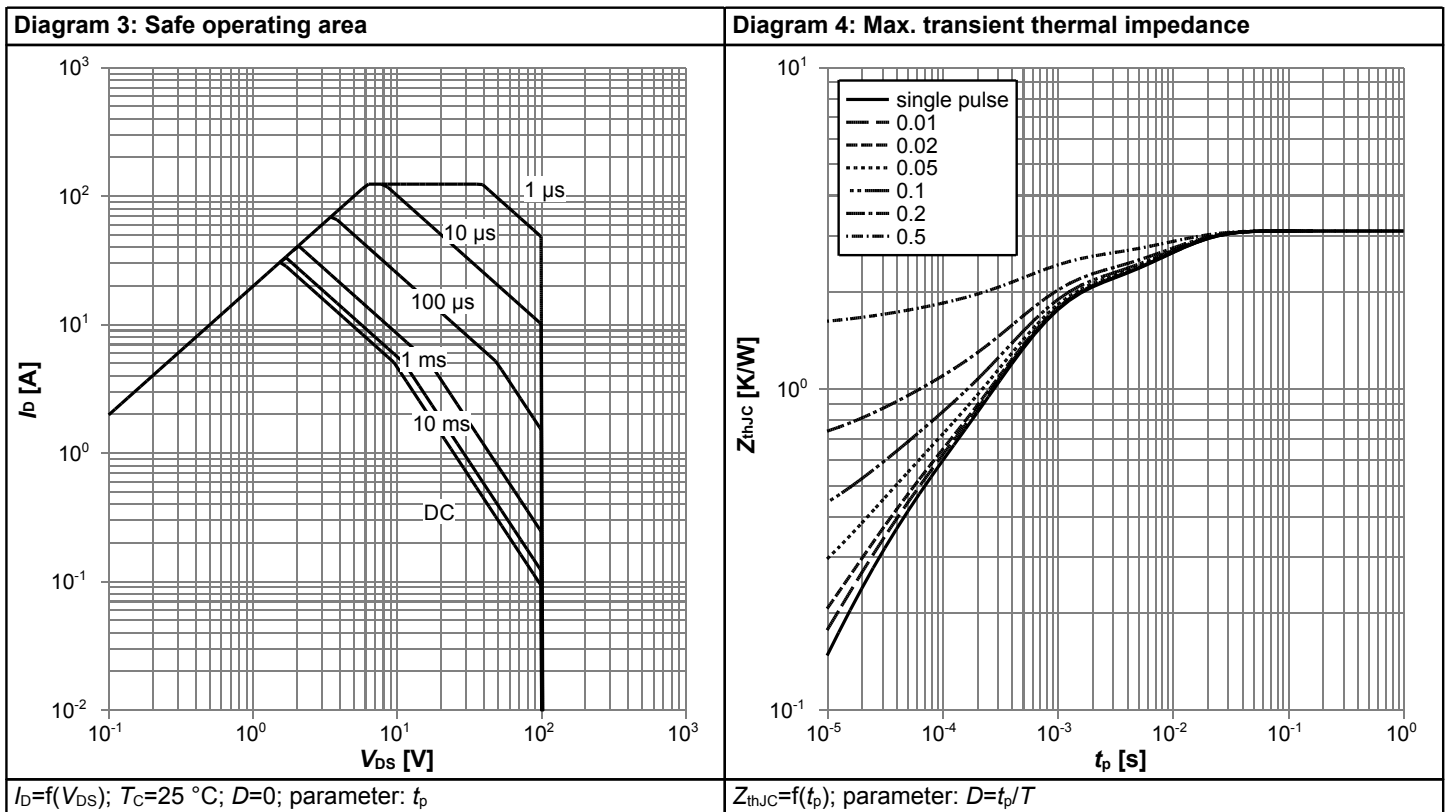
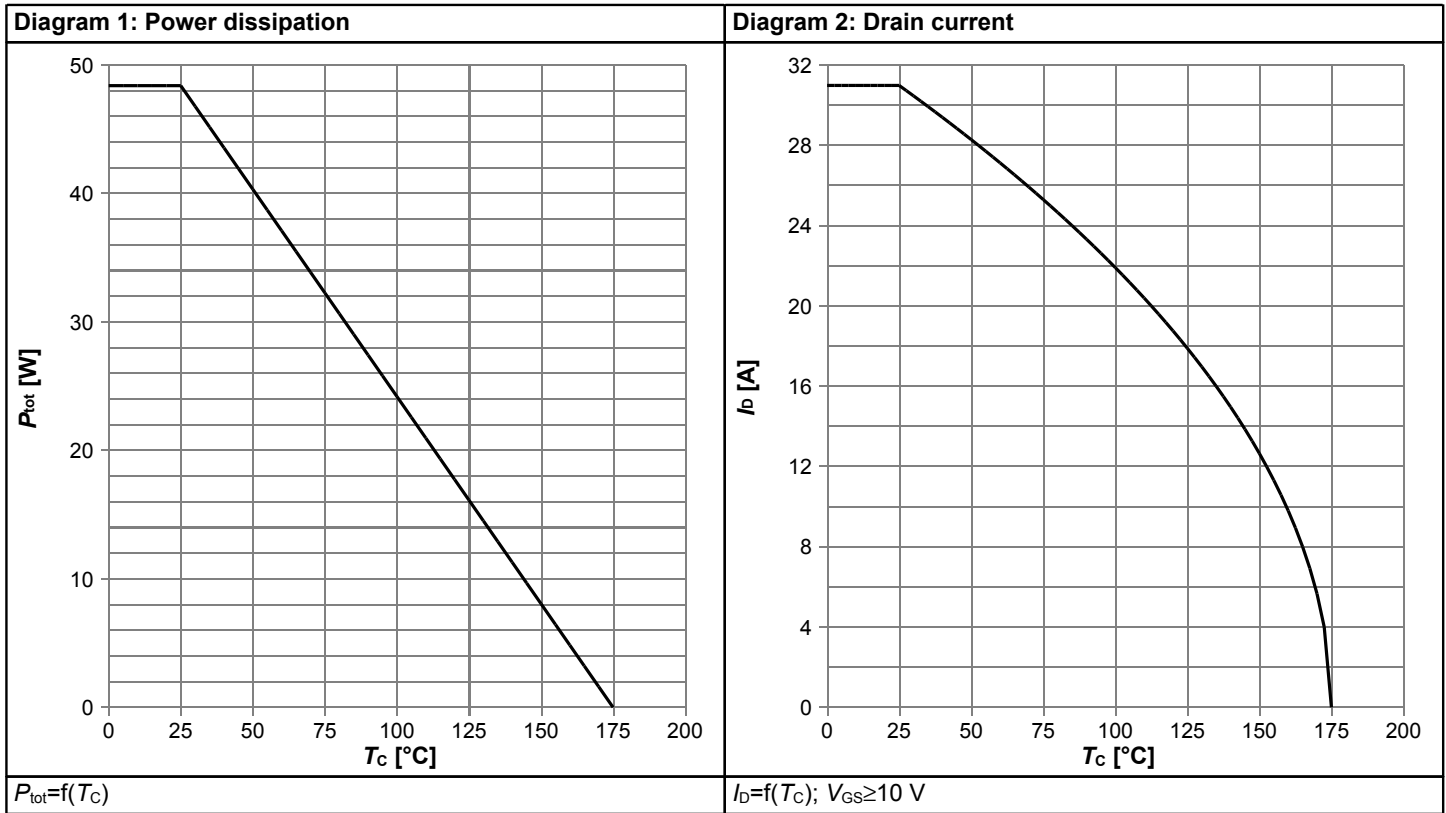
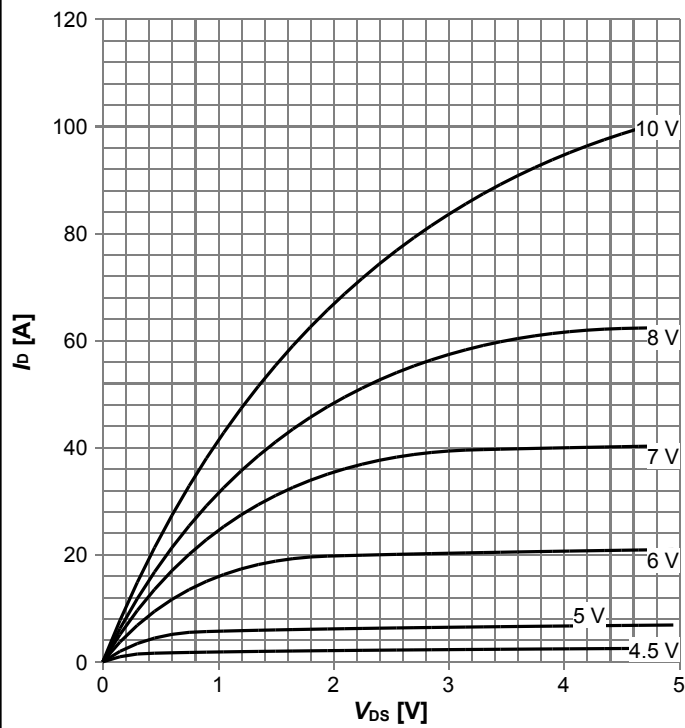
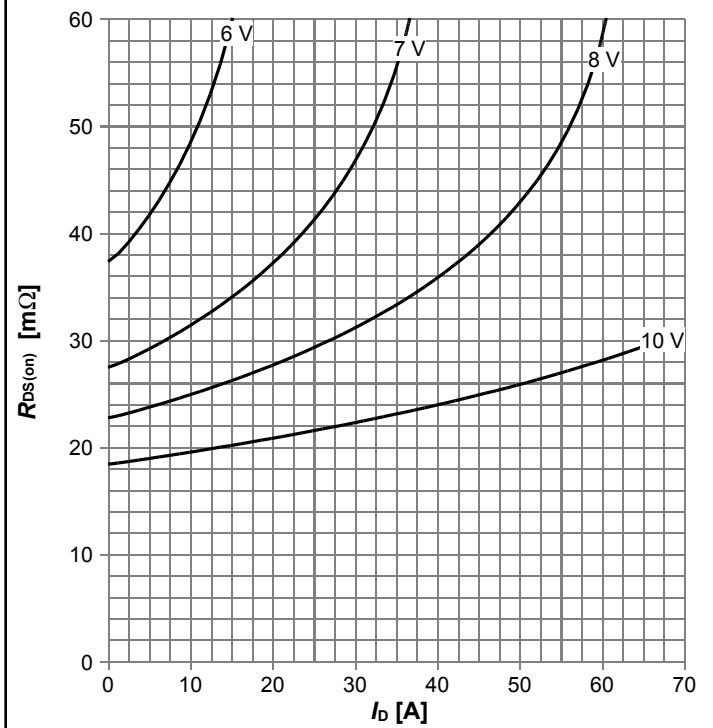


Diagram 5: Typ. output characteristics



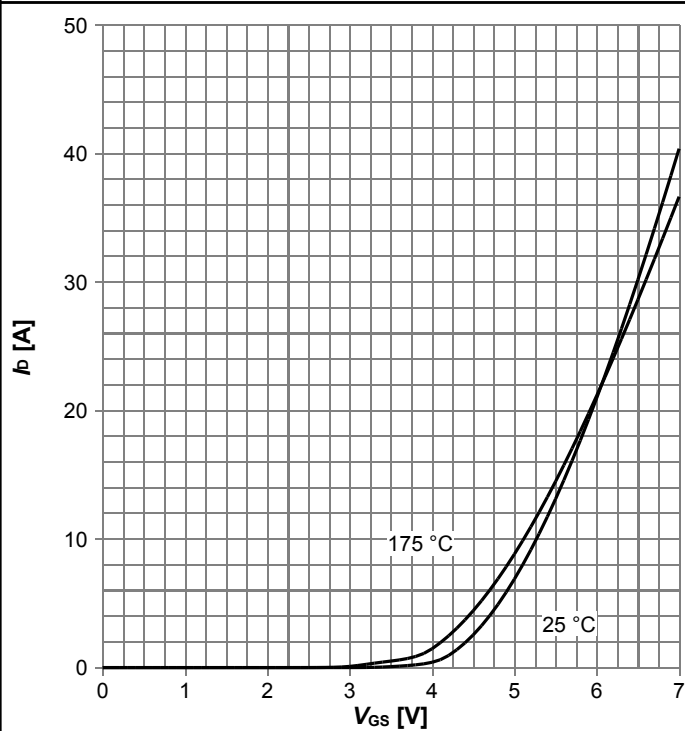
$I_D = f(V_{DS})$ ,  $T_j = 25^\circ\text{C}$ ; parameter:  $V_{GS}$

Diagram 6: Typ. drain-source on resistance



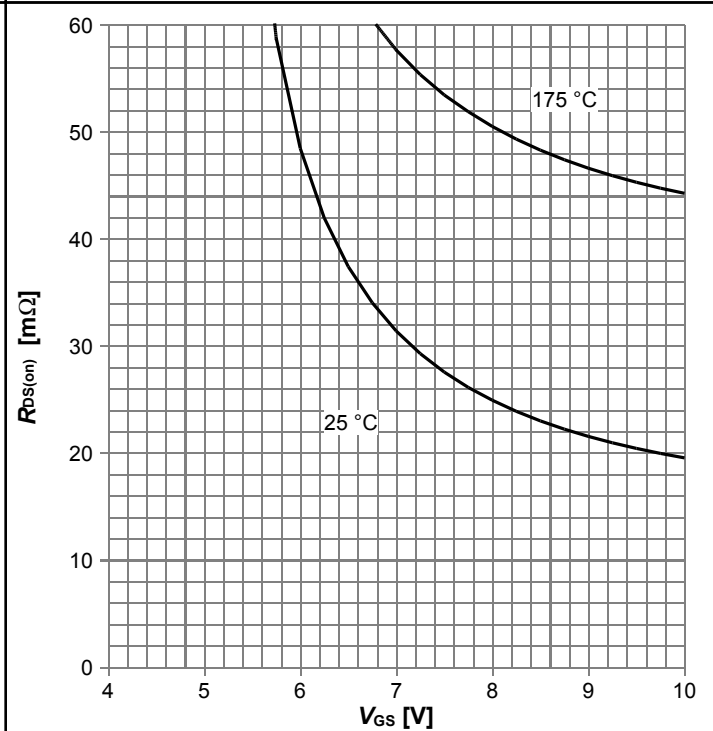
$R_{DS(on)} = f(I_D)$ ,  $T_j = 25^\circ\text{C}$ ; parameter:  $V_{GS}$

Diagram 7: Typ. transfer characteristics



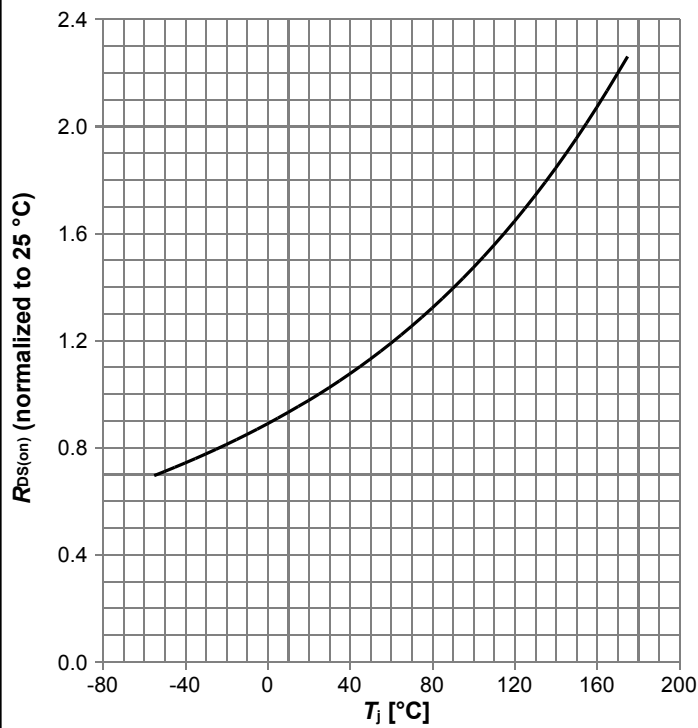
$I_D = f(V_{GS})$ ,  $|V_{DS}| > 2|I_D|R_{DS(on)max}$ ; parameter:  $T_j$

Diagram 8: Typ. drain-source on resistance



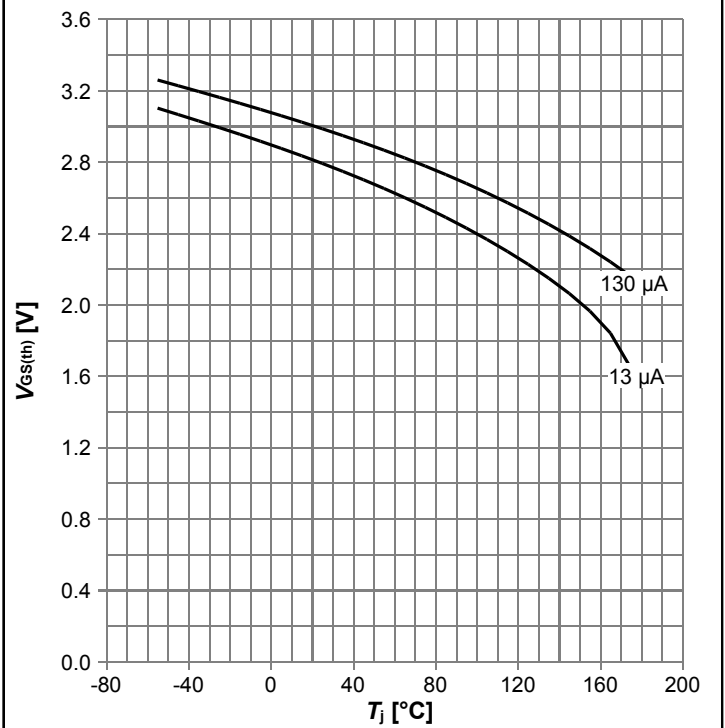
$R_{DS(on)} = f(V_{GS})$ ,  $I_D = 10\text{ A}$ ; parameter:  $T_j$

Diagram 9: Normalized drain-source on resistance



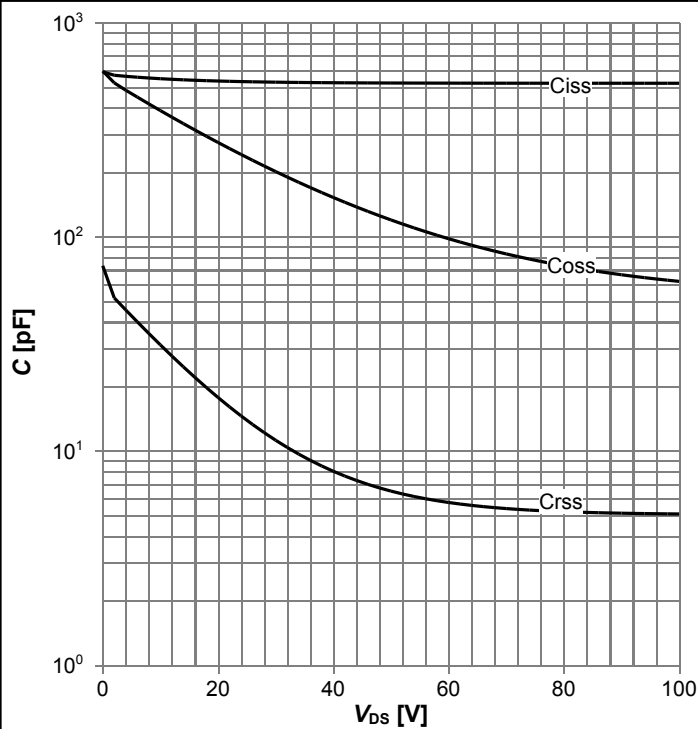
$R_{DS(on)}=f(T_j)$ ,  $I_D=10$  A,  $V_{GS}=10$  V

Diagram 10: Typ. gate threshold voltage



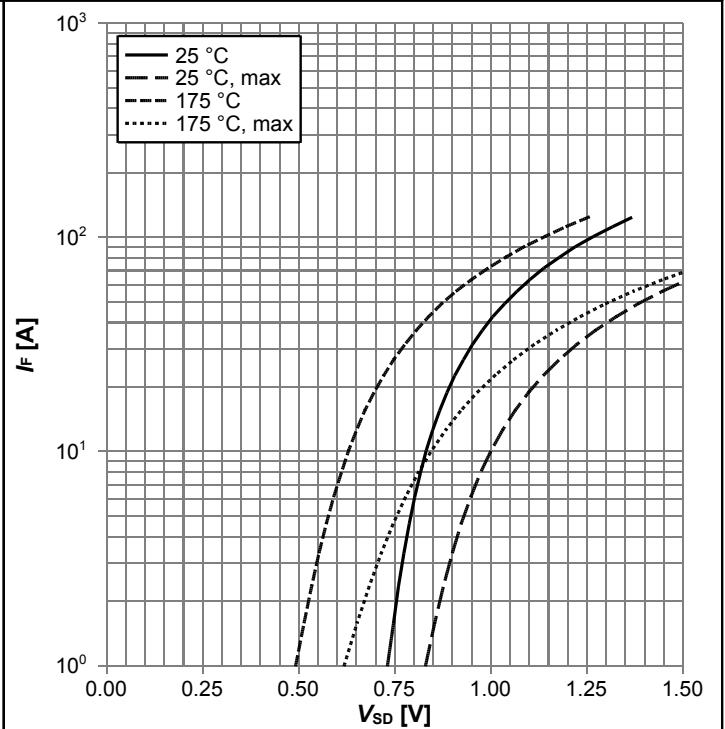
$V_{GS(th)}=f(T_j)$ ,  $V_{GS}=V_{DS}$ ; parameter:  $I_D$

Diagram 11: Typ. capacitances



$C=f(V_{DS})$ ;  $V_{GS}=0$  V;  $f=1$  MHz

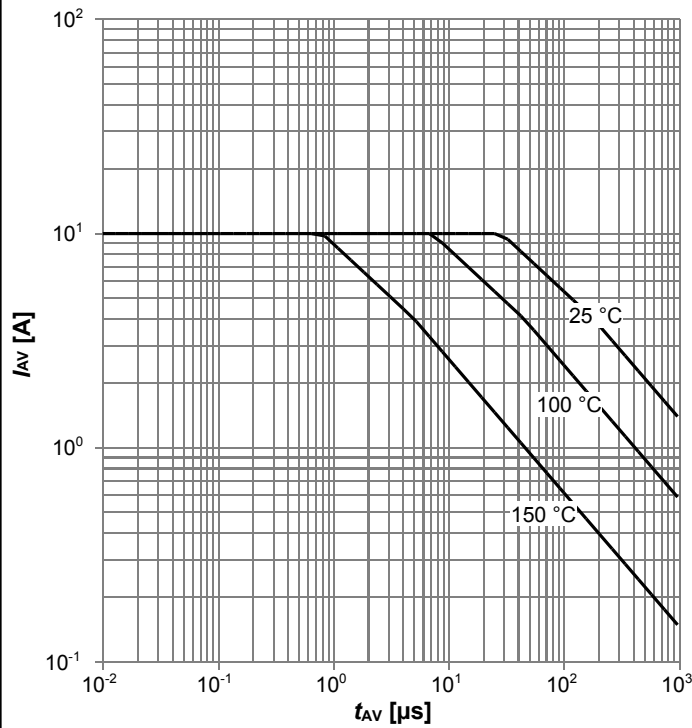
Diagram 12: Forward characteristics of reverse diode



$I_F=f(V_{SD})$ ; parameter:  $T_j$

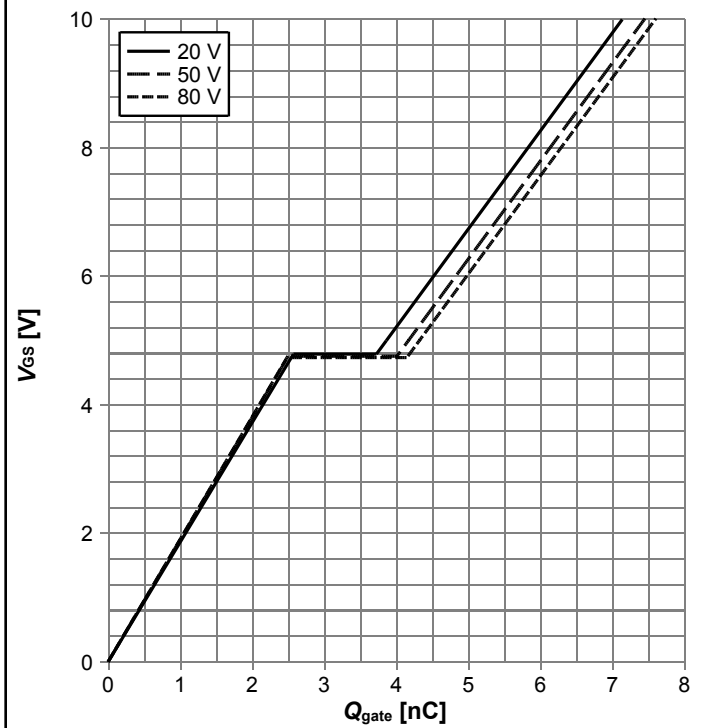


Diagram 13: Avalanche characteristics



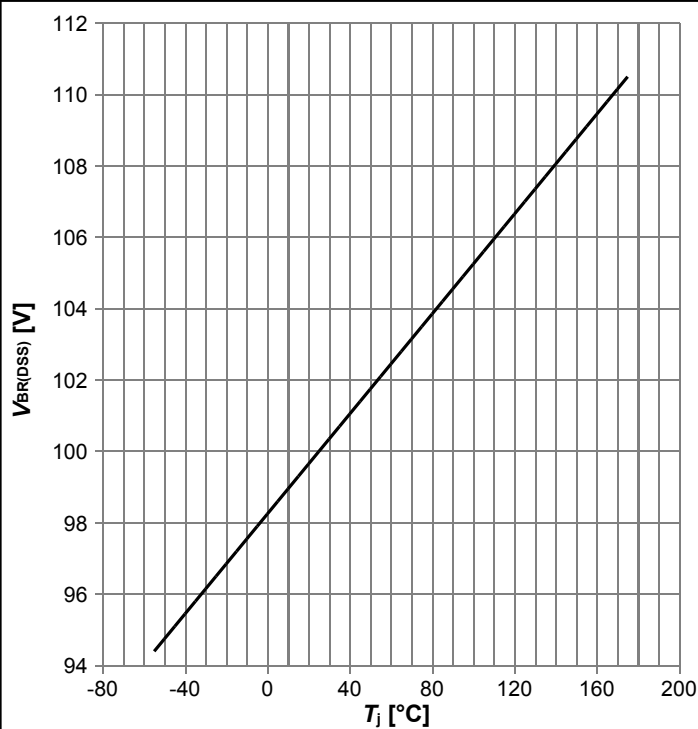
$I_{AS}=f(t_{AV}); R_{GS}=25 \Omega$ ; parameter:  $T_{j,start}$

Diagram 14: Typ. gate charge



$V_{GS}=f(Q_{gate}), I_D=5 \text{ A pulsed}, T_j=25 \text{ °C}$ ; parameter:  $V_{DD}$

Diagram 15: Drain-source breakdown voltage

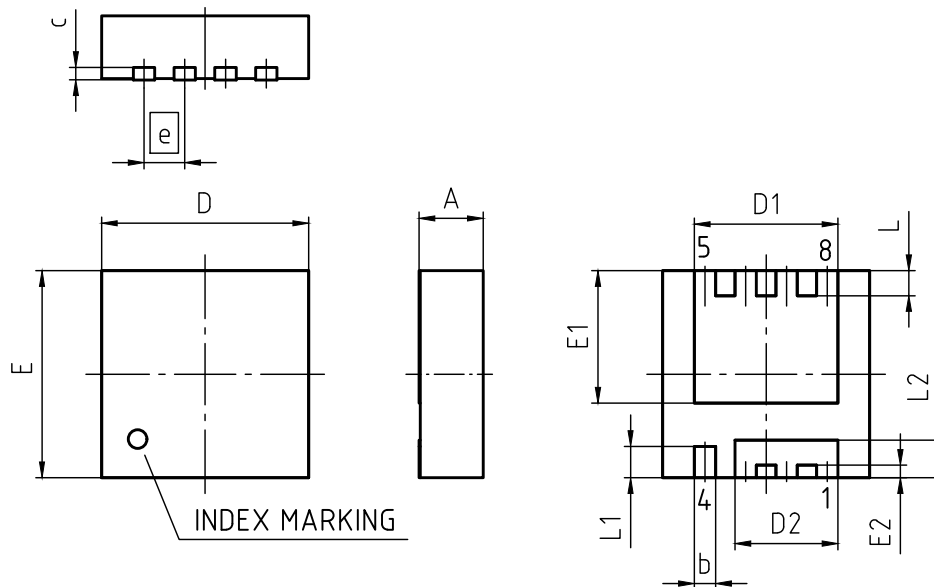


$V_{BR(DSS)}=f(T_j); I_D=10 \text{ mA}$

Diagram Gate charge waveforms



## 5 Package Outlines



PACKAGE - GROUP NUMBER: <b>PG-TSDSON-8-U03</b>		
REVISION: 03	DATE: 20.10.2020	
DIMENSIONS	MILLIMETERS	
	MIN.	MAX.
<b>A</b>	0.90	1.10
<b>b</b>	0.24	0.44
<b>c</b>	(0.20)	
<b>D</b>	3.20	3.40
<b>D1</b>	2.19	2.39
<b>D2</b>	1.54	1.74
<b>E</b>	3.20	3.40
<b>E1</b>	2.01	2.21
<b>E2</b>	0.10	0.30
<b>e</b>	0.65	
<b>L</b>	0.30	0.50
<b>L1</b>	0.40	0.60
<b>L2</b>	0.50	0.70
<b>aaa</b>	0.06	

Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm

## Revision History

ISZ230N10NM6

**Revision: 2023-02-10, Rev. 2.2**

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2021-07-05	Release of final version
2.1	2021-07-20	Update Diagram 10 and IAS
2.2	2023-02-10	Update SOA Diagram

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